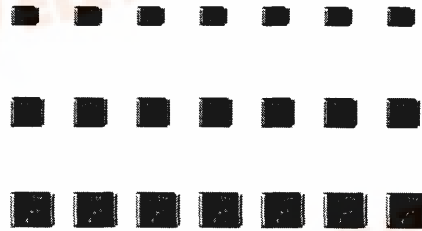


WIMA SMD 1812 NEW

WIMA SMD 2220-N NEW

WIMA SMD 2824-N NEW



Metallized polyester SMD capacitors

■ A capacitance range from 1000 pF through 2.2 μ F in size codes 1812, 2220 and 2824 allows for complete substitution of Ceramic Chip capacitors with corresponding size and capacitance values. ■ As with Ceramic Chip capacitors the entire surface of the end sides being used as soldering surface results in excellent soldering quality. ■ The excellent electrical properties open up applications where quality and reliability are of importance. ■ Available in 12 mm blister pack.

Technical Data/ General Data

Dielectric: Polyethylene terephthalate film.

Capacitor electrodes: Vacuum-deposited aluminium.

Encapsulation: Flame retardant plastic case,

UL 94 V-0. Colour: Black. Marking: Silver.

Temperature range: -55° C to +100° C.

Test specifications: In accordance with IEC 60384-19 and EN 132200 (u. prep.).

Test category: 55/100/21 in accordance with IEC.

Insulation resistance at +20° C:

Ur	Utest	C ≤ 0.33 μ F	0.33 μ F < C ≤ 2.2 μ F
63 VDC >=100VDC	50 V 100V	>=3.75 x 10 ³ MOhms Mean value: 1x10 ⁴ MOhms	>= 1250 sec. (MOhms x μ F) Mean value: 3000 sec.

In accordance with IEC 60384-19 and EN 132200 (u. prep.). Measuring time: 1 min.

Dissipation factors at +20° C: tan delta

at f	C ≤ 0.1 μ F	0.1 μ F < C ≤ 1.0 μ F	C > 1.0 μ F
1 kHz	≤ 8 x 10 ⁻³	≤ 8 x 10 ⁻³	≤ 10 x 10 ⁻³
10 kHz	≤ 15 x 10 ⁻³	≤ 15 x 10 ⁻³	-
100 kHz	≤ 30 x 10 ⁻³	-	-

Temperature characteristics:

Test voltage: 1.6 Ur, 2 sec.

Capacitance tolerances: +/-20 %, +/-10 %, (+/-5 % available subject to special enquiry).

Maximum pulse rise time:

Capacitance pF/ μ F	Pulse rise time V/ μ sec max.operation/test		
	63 VDC	100 VDC	250 VDC
1000 ...6800	20/200	20/200	20/200
0.01 ...0.022	15/150	20/200	20/200
0.033...0.068	10/100	15/150	20/200
0.1...0.15	5/50	10/100	15/150
0.22...1.0	2/20	6/60	10/100
1.5...2.2	2/20	-	-

for pulses equal to the rated voltage.

Voltage derating: A voltage derating factor of 1.25% per K must be applied from +85° C for DC voltages and from +75° C for AC voltages.

Vibration: 6 hours at 10. .2000 Hz and 0.75 mm displacement amplitude or 10 g in accordance with IEC 60068-2-6.

Low air density: 1 kPa = 10 mbar in accordance with IEC 60068-2-13.

Bump test: 4000 bumps at 390 m/sec² in accordance with IEC 60068-2-29.

Resistance to soldering heat:

Solder bath temperature max. 260°C.

Soldering duration max. 5 sec.

Change in capacitance Delta C/C<3%.

In accordance with DIN IEC 60068-2-20 (test Tb.) / EN 132200 (u. prep)

Soldering process: Wave soldering and re-flow soldering.

Taping:

WIMA SMD 2824

Metallized polyester capacitors

■ A capacitance range from 0.01 μF through 1 μF in size code 2824 allows for complete substitution of other chip capacitors with corresponding size and capacitance values. ■ The entire surface of the end sides being used as soldering surface results in excellent soldering quality. ■ The excellent electrical properties open up applications where quality and reliability are of importance. ■ Available in 12 mm blister pack.

Technical Data

Dielectric: Polyethylene terephthalate film.

Capacitor electrodes: Vacuum-deposited aluminium.

Encapsulation: Flame-retardant plastic case, UL 94 V-O, with epoxy resin seal. Colour: White or Black. Marking: Silver.

Temperature range: -55°C to $+100^{\circ}\text{C}$.

Test specifications: In accordance with IEC 384-19 and CECC 32 200.

Test category: 55/100/56 in accordance with IEC.

Insulation resistance at $+20^{\circ}\text{C}$:

V_r	V_{test}	$C \leq 0.33 \mu\text{F}$	$0.33 \mu\text{F} < C \leq 1.0 \mu\text{F}$
40 VDC	10 V	$\geq 3.75 \times 10^3 \text{ M}\Omega$	$\geq 1250 \text{ sec (M}\Omega \times \mu\text{F)}$
63 VDC	50 V	Mean value:	Mean value:
100 VDC	100 V	$1 \times 10^4 \text{ M}\Omega$	3000 sec

In accordance with IEC 384-19 and CECC 32 200.

Measuring time: 1 min.

Dissipation factors at $+20^{\circ}\text{C}$: $\tan \delta$

at f	$C \leq 0.1 \mu\text{F}$	$0.1 \mu\text{F} < C \leq 1.0 \mu\text{F}$
1 kHz	$\leq 8 \times 10^{-3}$	$\leq 8 \times 10^{-3}$
10 kHz	$\leq 15 \times 10^{-3}$	$\leq 15 \times 10^{-3}$
100 kHz	$\leq 30 \times 10^{-3}$	-

Capacitance tolerances: $\pm 20\%$ (closer tolerances are available subject to special enquiry).

Temperature characteristics: See graph page 18.

Maximum pulse rise time:

Capacitance μF	Pulse rise time V/ μsec	
	max. operation	test
0.01 ... 0.022	30	300
0.033 ... 0.068	20	200
0.1 ... 0.22	10	100
0.33 ... 0.68	8	80
1.0	5	50

for pulses equal to the rated voltage.

Test voltage: 1.6 V_r , 2 sec.

Vibration: 6 hours at 10 ... 2000 Hz and 0.75 mm displacement amplitude or 10 g in accordance with IEC 68-2-6.

Low air density: 1 kPa = 10 mbar in accordance with IEC 68-2-13.

Bump test: 4000 bumps at 390 m/sec² in accordance with IEC 68-2-29.

Resistance to soldering heat:

Solder bath temperature $\geq 260^{\circ}\text{C}$.

Soldering duration max. 5 sec. $\left| \frac{\Delta C}{C} \right| < 3\%$.

Change in capacitance

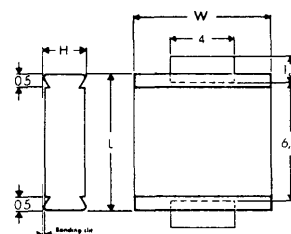
In accordance with DIN IEC 68-2-20 (test Tb.)/CECC 32 200.

Soldering process: Wave soldering and re-flow soldering (see temperature/time graphs page 17).

General Data

Capacitance	40 VDC / 25 VAC*			63 VDC / 40 VAC*			100 VDC / 63 VAC*		
	L	W	H	L	W	H	L	W	H
± 0.2	± 0.2	± 0.2	± 0.2	± 0.2	± 0.2	± 0.2	± 0.2	± 0.2	± 0.2
0.01 μF				7.3	6	2.5	7.3	6	2.5
0.015 "				7.3	6	2.5	7.3	6	2.5
0.022 "				7.3	6	2.5	7.3	6	2.5
0.033 "				7.3	6	2.5	7.3	6	2.5
0.047 "				7.3	6	2.5	7.3	6	2.5
0.068 "				7.3	6	2.5	7.3	6	2.5
0.1 μF				7.3	6	2.5	7.3	6	2.5
0.15 "				7.3	6	2.5			
0.22 "				7.3	6	3			
0.33 "				7.3	6	3.5			
0.47 "				7.3	6	3.5			
0.68 "	7.3	6	4.5						
1.0 μF	7.3	6	4.5						

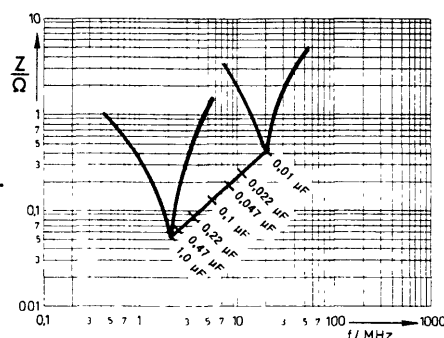
* AC voltage: $f = 50 \text{ Hz}$;
 $1.4 \times V_{\text{rms}} + \text{VDC} \leq$
VDC (rated)



Dims. in mm.

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Solder pad
recommendation



Impedance change
with frequency
(general guide)